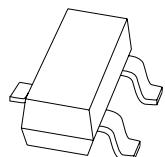


DATA SHEET



PBSS4140T
40 V, 1A
NPN low V_{CEsat} (BISS) transistor

Product data sheet
Supersedes data of 2005 Feb 14

2005 Feb 24

40 V, 1A NPN low V_{CEsat} (BISS) transistor

PBSS4140T

FEATURES

- Low collector-emitter saturation voltage
- High current capabilities.
- Improved device reliability due to reduced heat generation.

APPLICATIONS

- General purpose switching and muting
- LCD backlighting
- Supply line switching circuits
- Battery driven equipment (mobile phones, video cameras and hand-held devices).

DESCRIPTION

NPN low V_{CEsat} transistor in a SOT23 plastic package.
 PNP complement: PBSS5140T.

MARKING

TYPE NUMBER	MARKING CODE ⁽¹⁾
PBSS4140T	ZT*

Note

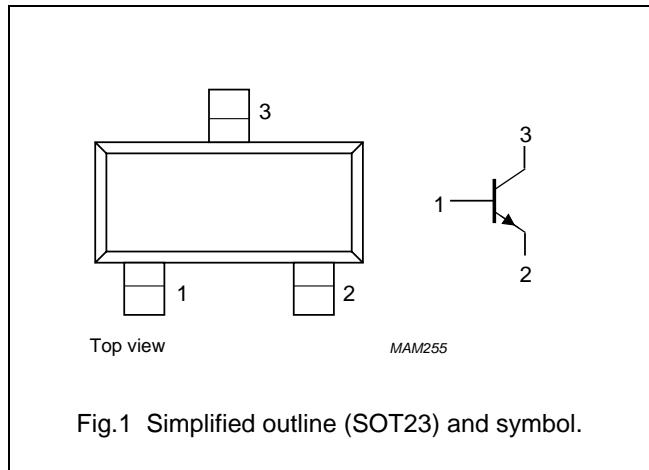
1. * = p: made in Hong Kong.
- * = t: made in Malaysia.
- * = W: made in China.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	MAX.	UNIT
V_{CEO}	collector-emitter voltage	40	V
I_{CM}	peak collector current	2	A
R_{CEsat}	equivalent on-resistance	<500	mΩ

PINNING

PIN	DESCRIPTION
1	base
2	emitter
3	collector

**ORDERING INFORMATION**

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
PBSS4140T	–	plastic surface mounted package; 3 leads	SOT23

**40 V, 1A
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PBSS4140T

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{CBO}	collector-base voltage	open emitter	–	40	V
V_{CEO}	collector-emitter voltage	open base	–	40	V
V_{EBO}	emitter-base voltage	open collector	–	5	V
I_C	collector current (DC)		–	1	A
I_{CM}	peak collector current		–	2	A
I_{BM}	peak base current		–	1	A
P_{tot}	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$; note 1	–	300	mW
		$T_{amb} \leq 25^\circ\text{C}$; note 2	–	450	mW
T_{stg}	storage temperature		–65	+150	°C
T_j	junction temperature		–	150	°C
T_{amb}	operating ambient temperature		–65	+150	°C

Notes

1. Device mounted on a printed-circuit board; single sided copper; tinplated; standard footprint.
2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm².

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air; note 1	417	K/W
		in free air; note 2	278	K/W

Notes

1. Device mounted on a printed-circuit board, single sided copper, tinplated and standard footprint.
2. Device mounted on a printed-circuit board, single sided copper, tinplated, mounting pad for collector 1 cm².

**40 V, 1A
NPN low V_{CEsat} (BISS) transistor**

PBSS4140T

CHARACTERISTICS

$T_{amb} = 25^\circ\text{C}$ unless otherwise specified.

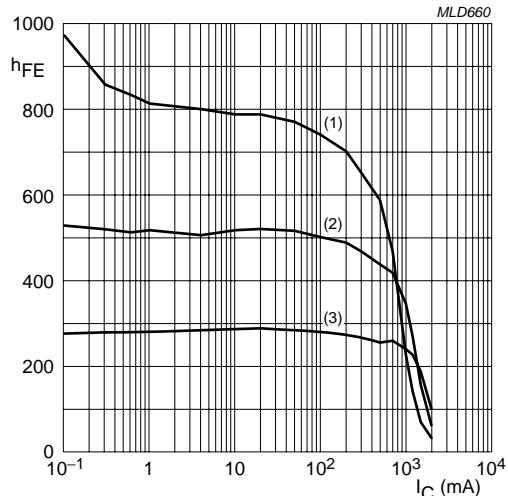
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I_{CBO}	collector-base cut-off current	$V_{CB} = 40 \text{ V}; I_E = 0 \text{ A}$	—	—	100	nA
		$V_{CB} = 40 \text{ V}; I_E = 0 \text{ A}; T_{amb} = 150^\circ\text{C}$	—	—	50	μA
I_{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_B = 0 \text{ A}$	—	—	100	nA
I_{EBO}	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_C = 0 \text{ A}$	—	—	100	nA
h_{FE}	DC current gain	$V_{CE} = 5 \text{ V}; I_C = 1 \text{ mA}$	300	—	—	
		$V_{CE} = 5 \text{ V}; I_C = 500 \text{ mA}$	300	—	900	
		$V_{CE} = 5 \text{ V}; I_C = 1 \text{ A}$	200	—	—	
V_{CEsat}	collector-emitter saturation voltage	$I_C = 100 \text{ mA}; I_B = 1 \text{ mA}$	—	—	200	mV
		$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}$	—	—	250	mV
		$I_C = 1 \text{ A}; I_B = 100 \text{ mA}$	—	—	500	mV
R_{CEsat}	equivalent on-resistance	$I_C = 500 \text{ mA}; I_B = 50 \text{ mA}; \text{note 1}$	—	260	<500	$\text{m}\Omega$
V_{BEsat}	base-emitter saturation voltage	$I_C = 1 \text{ A}; I_B = 100 \text{ mA}$	—	—	1.2	V
V_{BEon}	base-emitter turn-on voltage	$V_{CE} = 5 \text{ V}; I_C = 1 \text{ A}$	—	—	1.1	V
f_T	transition frequency	$I_C = 50 \text{ mA}; V_{CE} = 10 \text{ V}; f = 100 \text{ MHz}$	150	—	—	MHz
C_c	collector capacitance	$V_{CB} = 10 \text{ V}; I_E = I_e = 0 \text{ A}; f = 1 \text{ MHz}$	—	—	10	pF

Note

1. Pulse test: $t_p \leq 300 \mu\text{s}; \delta \leq 0.02$.

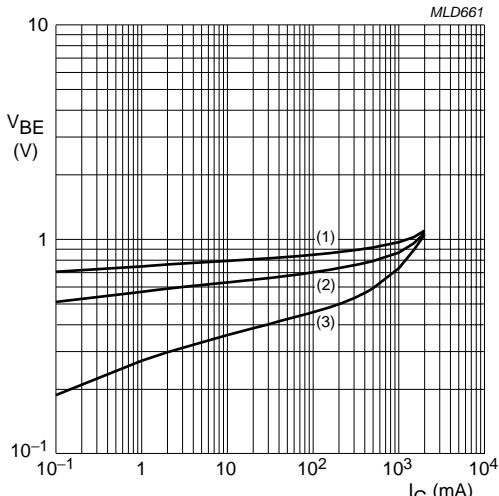
**40 V, 1A
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PBSS4140T



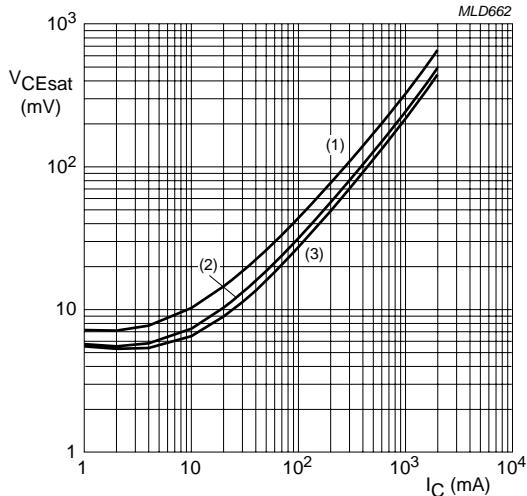
- $V_{CE} = 5 \text{ V}.$
(1) $T_{\text{amb}} = 150 \text{ }^{\circ}\text{C}.$
(2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}.$
(3) $T_{\text{amb}} = -55 \text{ }^{\circ}\text{C}.$

Fig.2 DC current gain as a function of collector current; typical values.



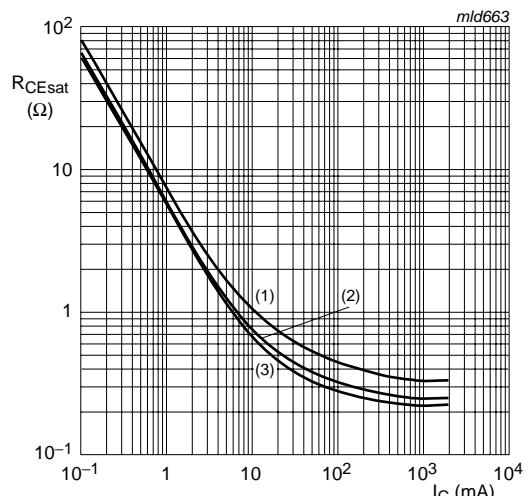
- $V_{CE} = 5 \text{ V}.$
(1) $T_{\text{amb}} = -55 \text{ }^{\circ}\text{C}.$
(2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}.$
(3) $T_{\text{amb}} = 150 \text{ }^{\circ}\text{C}.$

Fig.3 Base-emitter voltage as a function of collector current; typical values.



- $I_C/I_B = 10.$
(1) $T_{\text{amb}} = 150 \text{ }^{\circ}\text{C}.$
(2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}.$
(3) $T_{\text{amb}} = -55 \text{ }^{\circ}\text{C}.$

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.

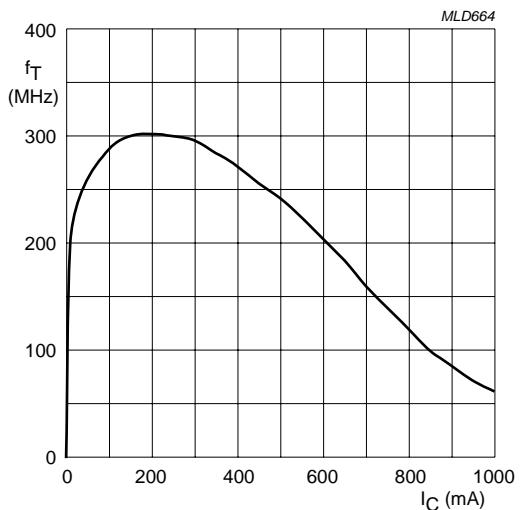


- $I_C/I_B = 10.$
(1) $T_{\text{amb}} = 150 \text{ }^{\circ}\text{C}.$
(2) $T_{\text{amb}} = 25 \text{ }^{\circ}\text{C}.$
(3) $T_{\text{amb}} = -55 \text{ }^{\circ}\text{C}.$

Fig.5 Equivalent on-resistance as a function of collector current; typical values.

40 V, 1A
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PBSS4140T



$V_{CE} = 10$ V.

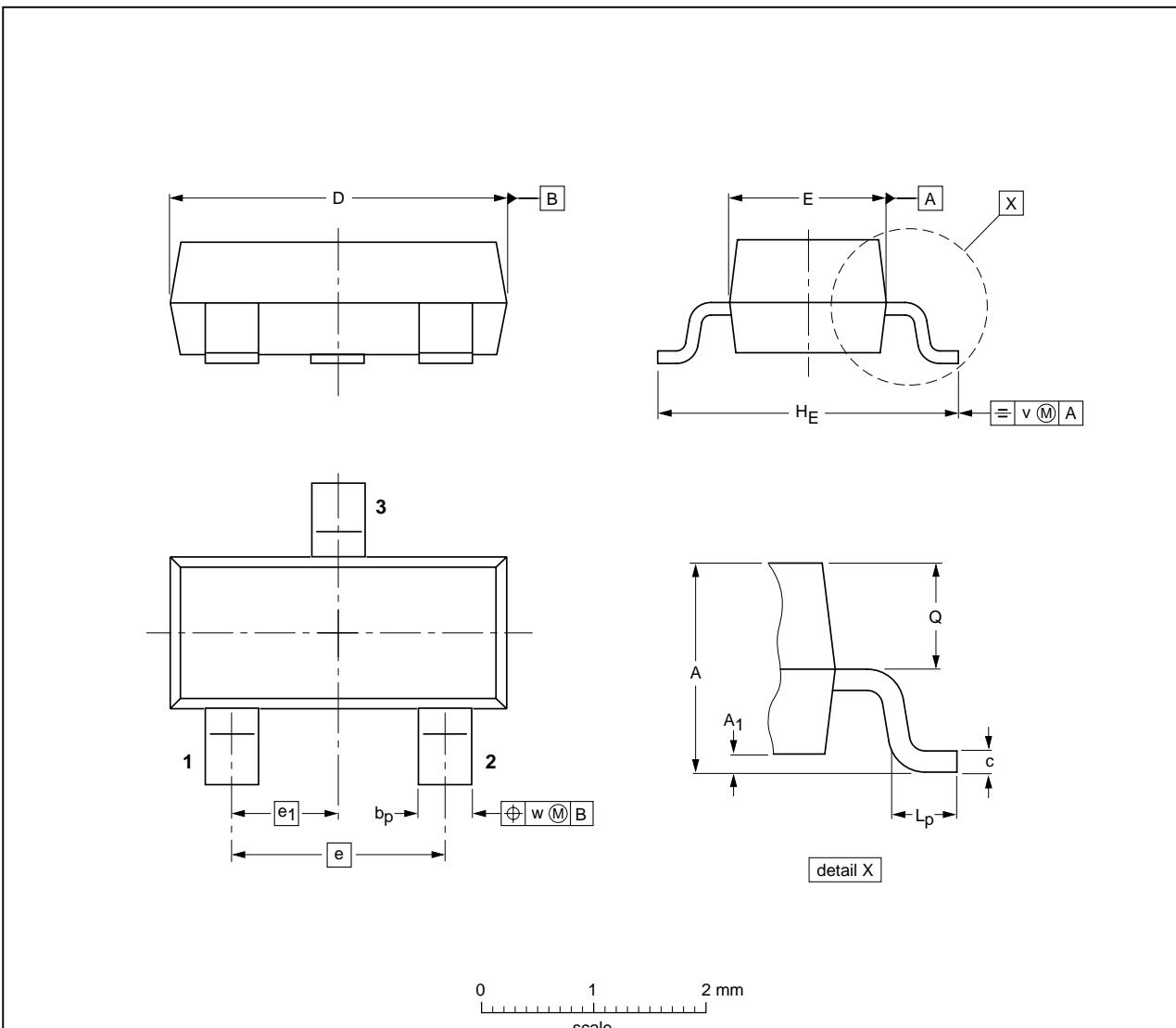
Fig.6 Transition frequency as a function of collector current.

**40 V, 1A
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PBSS4140T

PACKAGE OUTLINE

Plastic surface-mounted package; 3 leads SOT23



DIMENSIONS (mm are the original dimensions)

UNIT	A	A_1 max.	b_p	c	D	E	e	e_1	H_E	L_p	Q	v	w
mm	1.1 0.9	0.1	0.48 0.38	0.15 0.09	3.0 2.8	1.4 1.2	1.9	0.95	2.5 2.1	0.45 0.15	0.55 0.45	0.2	0.1

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT23		TO-236AB				-04-11-04- 06-03-16